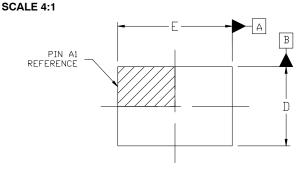
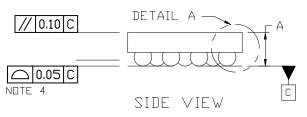
WLCSP11, 2.04x1.41x0.66 CASE 766AJ ISSUE B

DATE 17 NOV 2020

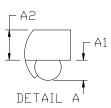


TOP VIEW



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 4. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 5. DIMENSION & IS MEASURED AT THE MAXIMUM BALL DIAMETER, PARALLEL TO DATUM C.

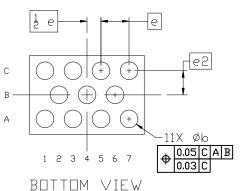


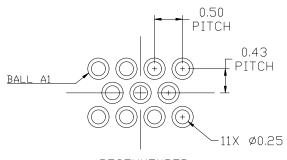
SEATING

PLANE

NOTE 3

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α			0.66	
A1	0.21	0.24	0.27	
A2	0.33	0.36	0.39	
b	0.290	0.315	0.340	
D	1.94	2.04	2.14	
E	1.31	1.41	1.51	
е	0.50 BSC			
e2	0.43 BSC			





RECOMMENDED
MOUNTING FOOTPRINT*
(NSMD PAD TYPE)

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

GENERIC MARKING DIAGRAM*

° XXXXXX AYWW

XXXXXX = Specific Device Code

A = Assembly Location Y = Year

WW = Work Week
■ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	WLCSP11, 2.04x1.41x0.66		PAGE 1 OF 1	

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